

SPECIFICATION

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor

- Part Number : **CL21F104ZBANNC**
- Description : **CAP, 100nF, -20+80%, 50V, Y5V, 0805**

A. Samsung Part Number

CL 21 F 104 Z B A N N N C
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

① Series	Samsung Multi-layer Ceramic Capacitor									
② Size	0805 (inch code)	L: 2.0	± 0.1	mm	W:	1.25	± 0.1	mm		
③ Dielectric	Y5V				⑧ Inner electrode	Ni				
④ Capacitance	100 nF				Termination	Cu				
⑤ Capacitance tolerance	-20/+80 %				Plating	Sn 100% (Pb Free)				
⑥ Rated Voltage	50 V				⑨ Product	Normal				
⑦ Thickness	0.65 ± 0.1 mm				⑩ Special	Reserved for future use				
					⑪ Packaging	Cardboard Type, 7" reel				

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition
Capacitance	Within specified tolerance	1kHz±10% 1.0±0.2Vrms
Tan δ (DF)	0.05 max.	
Insulation Resistance	10,000Mohm or 500Mohm·μF Whichever is Smaller	Rated Voltage 60~120 sec.
Appearance	No abnormal exterior appearance	Microscope (×10)
Withstanding Voltage	No dielectric breakdown or mechanical breakdown	250% of the rated voltage
Temperature Characterisitcs	Y5V (From -30℃ to 85℃, Capacitance change should be within -82~+22%)	
Adhesive Strength of Termination	No peeling shall be occur on the terminal electrode	500g-F, for 10±1 sec.
Bending Strength	Capacitance change : within ±30%	Bending to the limit (1mm) with 1.0mm/sec.
Solderability	More than 95% of terminal surface is to be soldered newly	1) Sn63Pb37 solder 235±5℃, 5±0.5sec. 2) SnAg3.0Cu0.5 solder 245±5℃, 3±0.3sec. (preheating : 80~120℃ for 10~30sec.)
Resistance to Soldering heat	Capacitance change : within ±20% Tan δ, IR : initial spec.	Solder pot : 270±5℃, 10±1sec.

	Performance	Test condition
Vibration Test	Capacitance change : within $\pm 20\%$ Tan δ , IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours \times 3 direction (x, y, z)
Humidity	Capacitance change : within $\pm 30\%$ Tan δ : 0.09 max IR : 1000Mohm or 50Mohm $\cdot \mu F$ Whichever is Smaller	40 ± 2 °C, 90~95%RH, 500+12/-0hrs
Moisture Resistance	Capacitance change : within $\pm 30\%$ Tan δ : 0.09 max IR : 500Mohm or 25Mohm $\cdot \mu F$ Whichever is Smaller	With rated voltage 40 ± 2 °C, 90~95%RH, 500+12/-0hrs
High Temperature Resistance	Capacitance change : within $\pm 30\%$ Tan δ : 0.09 max IR : 1000Mohm or 50Mohm $\cdot \mu F$ Whichever is Smaller	With 200% of the rated voltage Max. operating temperature 1000+48/-0hrs
Temperature Cycling	Capacitance change : within $\pm 20\%$ Tan δ , IR : initial spec.	1 cycle condition Min. operating temperature \rightarrow 25°C \rightarrow Max. operating temperature \rightarrow 25°C 5 cycle test

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 250 ± 5 °C, 6sec. Max)

* For the more detail Specification, Please refer to the Samsung MLCC catalogue.